# Hyperfast Rectifier, 3 A FRED Pt®



## LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS          |                    |  |  |  |
|----------------------------------|--------------------|--|--|--|
| I <sub>F(AV)</sub> 3 A           |                    |  |  |  |
| V <sub>R</sub>                   | 200 V              |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> | 0.74 V             |  |  |  |
| t <sub>rr</sub>                  | 30 ns              |  |  |  |
| T <sub>J</sub> max.              | 175 °C             |  |  |  |
| Package                          | SlimSMA (DO-221AC) |  |  |  |
| Circuit configuration            | Single             |  |  |  |

### FEATURES

- Hyperfast recovery time, reduced Q<sub>rr</sub>, and soft recovery
- 175 °C maximum operating junction temperature
- Specific for output and snubber operation
- · Low forward voltage drop
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

## **DESCRIPTION / APPLICATIONS**

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, piezo-injection, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

## MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating **Terminals:** matte tin plated leads, solderable per J-STD-002

Polarity: color band denotes cathode end

| ABSOLUTE MAXIMUM RATINGS                    |                                   |                                    |             |       |
|---|-----------------------------------|------------------------------------|-------------|-------|
| PARAMETER                                   | SYMBOL                            | TEST CONDITIONS                    | VALUES      | UNITS |
| Peak repetitive reverse voltage             | V <sub>RRM</sub>                  |                                    | 200         | V     |
| Average rectified forward current           | I <sub>F(AV)</sub>                | $T_{C} = 145 \ ^{\circ}C \ ^{(1)}$ | 3           | ٨     |
| Non-repetitive peak surge current           | I <sub>FSM</sub>                  | T <sub>J</sub> = 25 °C             | 85          | A     |
| Operating junction and storage temperatures | T <sub>J</sub> , T <sub>Stg</sub> |                                    | -65 to +175 | °C    |

#### Note

<sup>(1)</sup> Device on PCB with 8 mm x 16 mm soldering lands

| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                  |   |      |      |      |       |
|--|----------------------------------|---|------|------|------|-------|
| PARAMETER  | SYMBOL                           | TEST CONDITIONS                                 | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage  | V <sub>BR</sub> , V <sub>R</sub> | I <sub>R</sub> = 100 μA                         | 200  | -    | -    |       |
| Forward voltage  | V <sub>F</sub>                   | I <sub>F</sub> = 3 A                            | -    | 0.86 | 0.93 | V     |
|  |                                  | I <sub>F</sub> = 3 A, T <sub>J</sub> = 125 °C   | -    | 0.74 | 0.78 |       |
| Reverse leakage current  |                                  | V <sub>R</sub> = V <sub>R</sub> rated           | -    | -    | 2    |       |
|  | IR                               | $T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$ | -    | 1    | 8    | μΑ    |
| Junction capacitance   | CT                               | V <sub>R</sub> = 200 V                          | -    | 13   | -    | pF    |

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| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified) |  |  |  |      |      |      |       |
|---|--|--|--|------|------|------|-------|
| PARAMETER   | SYMBOL   | TEST CONDITIONS  |  | MIN. | TYP. | MAX. | UNITS |
|   |  |  | $I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 50 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}$ |      | 26   | -    |       |
| Reverse recovery time t <sub>rr</sub>   | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A |  | -  | -    | 30   |      |       |
|   | T <sub>J</sub> = 25 °C   |  | -  | 18   | -    | ns   |       |
|   | T <sub>J</sub> = 125 °C  |  | -  | 26   | -    |      |       |
| Peak recovery current I <sub>RRM</sub>  | T <sub>J</sub> = 25 °C   | I <sub>F</sub> = 3 A<br>dI <sub>F</sub> /dt = 200 A/µs<br>V <sub>R</sub> = 160 V | -  | 2.5  | -    | ^    |       |
|   | T <sub>J</sub> = 125 °C  |  | -  | 4    | -    | A    |       |
| Reverse recovery charge Q <sub>rr</sub>   | T <sub>J</sub> = 25 °C   |  | -  | 23   | -    | nC   |       |
|   | T <sub>J</sub> = 125 °C  |  | -  | 50   | -    | 10   |       |

| <b>THERMAL - MECHANICAL SPECIFICATIONS</b> ( $T_J$ = 25 °C unless otherwise specified) |                                   |  |                           |        |      |       |
|--|-----------------------------------|--|---------------------------|--------|------|-------|
| PARAMETER  | SYMBOL                            | TEST CONDITIONS  | TEST CONDITIONS MIN. TYP. |        | MAX. | UNITS |
| Maximum junction and storage temperature range   | T <sub>J</sub> , T <sub>Stg</sub> |  | -65                       | -      | 175  | °C    |
| Thermal resistance, junction to mount  | R <sub>thJM</sub>                 | Device mounted on PCB with<br>8 mm x 16 mm soldering lands | -                         | 8      | 10   | °C/W  |
| Thermal resistance, junction to ambient  | R <sub>thJA</sub>                 | Device mounted on PCB with 2 mm x 3.5 mm soldering lands   | -                         | 91     | 110  | C/VV  |
| Approximate Weight   |                                   |  |                           | 0.032  |      | g     |
| Approximate Weight   |                                   |  |                           | 0.0011 |      | oz.   |
| Marking device   |                                   | Case style SlimSMA (DO-221AC)                              |                           | 31     | H2   |       |

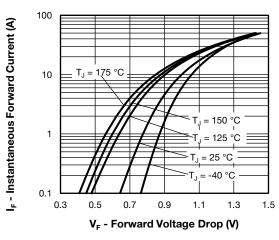


Fig. 1 - Typical Forward Voltage Drop Characteristics

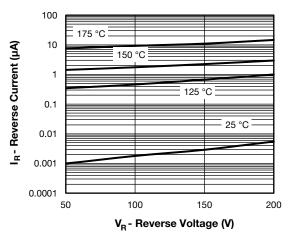
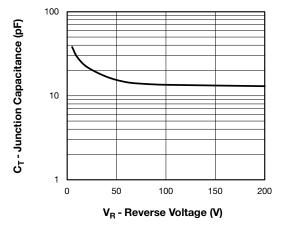


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage





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Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

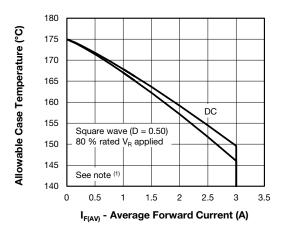


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current

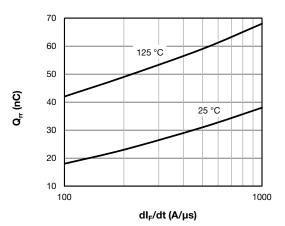


Fig. 7 - Typical Stored Charge vs. dl<sub>F</sub>/dt

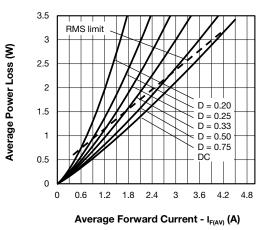


Fig. 5 - Forward Power Loss Characteristics

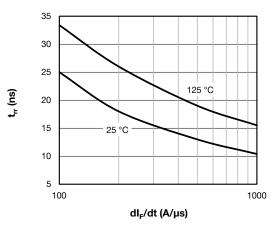


Fig. 6 - Typical Reverse Recovery vs. dl<sub>F</sub>/dt

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Note

<sup>&</sup>lt;sup>(1)</sup> Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;

Pd = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see Fig. 6);  $Pd_{REV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$ 

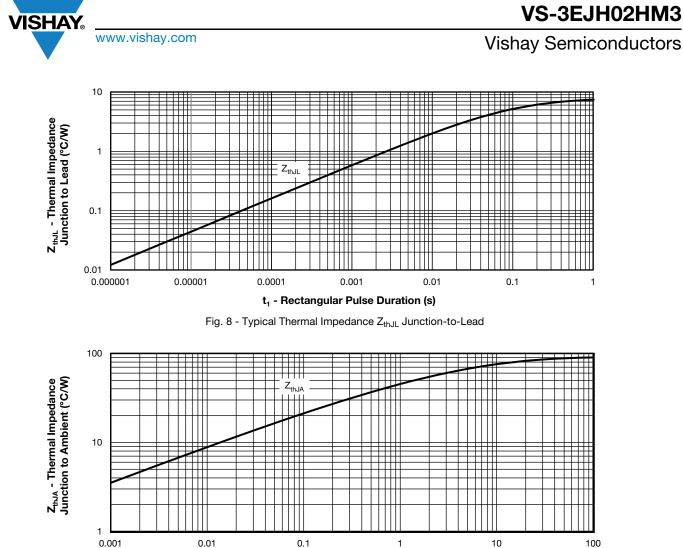




Fig. 9 - Typical Thermal Impedance Z<sub>thJA</sub> Junction-to-Ambient

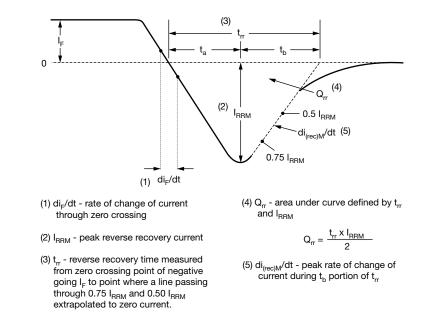


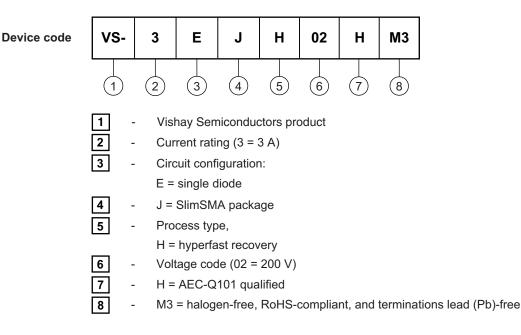
Fig. 10 - Reverse Recovery Waveform and Definitions

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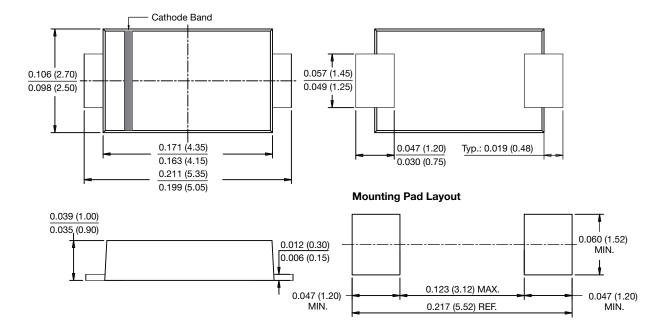
| ORDERING INFORMATION (Example) |                   |                        |                                   |  |  |  |
|--------------------------------|-------------------|------------------------|-----------------------------------|--|--|--|
| PREFERRED P/N                  | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION             |  |  |  |
| VS-3EJH02HM3/6A                | 3500              | 3500                   | 7"diameter plastic tape and reel  |  |  |  |
| VS-3EJH02HM3/6B                | 14 000            | 14 000                 | 13"diameter plastic tape and reel |  |  |  |

| LINKS TO RELATED DOCUMENTS          |                          |  |  |  |
|-------------------------------------|--------------------------|--|--|--|
| Dimensions www.vishay.com/doc?95571 |                          |  |  |  |
| Part marking information            | www.vishay.com/doc?95562 |  |  |  |
| Packaging information               | www.vishay.com/doc?88869 |  |  |  |
| SPICE model                         | www.vishay.com/doc?96050 |  |  |  |



# DO-221AC (SlimSMA)

## **DIMENSIONS** in inches (millimeters)





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